

# **TABLE OF CONTENTS: ADHESION MEASUREMENT METHODS: THEORY AND PRACTICE (CRC PRESS, 2006)**

## **INTRODUCTION**

### **1.1 OVERVIEW**

### **1.2 WHAT IS ADHESION AND CAN IT BE MEASURED?**

### **1.3 COMMENTS ON NOMENCLATURE AND USAGE**

## **2. OVERVIEW OF MOST COMMON ADHESION MEASUREMENT METHODS**

### **2.1 PREAMBLE**

### **2.2 PEEL TEST**

- 2.2.1 Introduction
- 2.2.2 Advantages of Peel Test
- 2.2.3 Disadvantages of Peel Test
- 2.2.4 Summary and Recommendations

### **2.3 TAPE PEEL TEST**

- 2.3.1 Introduction
- 2.3.2 Advantages of the Tape Peel Test
- 2.3.3 Disadvantages of Tape Peel Test
- 2.3.4 Summary and Recommendations

### **2.4 PULL TEST**

- 2.4.1 Introduction
- 2.4.2 Advantages of Pull Test
- 2.4.3 Disadvantages of the Pull Test
- 2.4.4 Summary and Recommendations

### **2.5 INDENTATION DEBONDING TEST**

- 2.5.1 Introduction
- 2.5.2 Advantages of Indentation Debonding Test
- 2.5.3 Disadvantages of Indentation Debonding Test
- 2.5.4 Summary and Recommendations

### **2.6 SCRATCH TEST**

- 2.6.1 Introduction
- 2.6.2 Advantages of the Scratch Test
- 2.6.3 Disadvantages of the Scratch Test
- 2.6.4 Summary and Recommendations

### **2.7 BLISTER TEST**

- 2.7.1 Introduction
- 2.7.2 Advantages of Blister Test
- 2.7.3 Disadvantages of the Blister Test
- 2.7.4 Summary and Recommendations

### **2.8 BEAM BENDING TESTS**

- 2.8.1 Introduction
- 2.8.2 Three Point Bend Test
- 2.8.3 Four Point Bend Test
- 2.8.4 Standard Double Cantilevered Beam Test
- 2.8.5 Tapered Double Cantilevered Beam Test
- 2.8.6 Double Cleavage Drilled Compression Test
- 2.8.7 Brazil Nut Test
- 2.8.8 Wedge Test

2.8.9 Topple Beam Test

2.8.10 Advantages of Beam Bending Tests

2.8.11 Disadvantages of Beam Bending Tests

2.8.12 Summary and Recommendations

### **2.9 SELF LOADING TESTS**

- 2.9.1 Circle Cut Test
- 2.9.2 MELT Test
- 2.9.3 Microstrip Test
- 2.9.4 Advantages of Self Loading Tests
- 2.9.5 Disadvantages of Self Loading Tests
- 2.9.6 Summary and Recommendations

### **2.10 MORE EXOTIC ADHESION MEASUREMENT METHODS**

- 2.10.1 Laser Spallation: Early Work
- 2.10.2 Later Refined Experiments
- 2.10.3 LIDS Experiment
- 2.10.4 Advantages of Laser Spallation Tests
- 2.10.5 Disadvantages of Laser Spallation Test
- 2.10.6 Summary and Recommendations

### **2.11 ELECTROMAGNETIC TEST**

- 2.11.1 Advantages of Electromagnetic Test
- 2.11.2 Disadvantages of Electromagnetic Test
- 2.11.3 Summary and Recommendations

### **2.12 NON-DESTRUCTIVE TESTS**

- 2.12.1 Dynamic Modulus Test
- 2.12.2 Advantages of Dynamic Modulus Test
- 2.12.3 Disadvantages of Dynamic Modulus Test
- 2.12.4 Summary and Recommendations
- 2.13 Surface Acoustic Waves Test
- 2.13.1 Advantages of Surface Acoustic Waves Test
- 2.13.2 Disadvantages of Surface Acoustic Waves Test
- 2.13.3 Summary and Recommendations

## **3 THEORETICAL FOUNDATIONS OF QUANTITATIVE ADHESION MEASUREMENT METHODS**

### **3.1 INTRODUCTION TO CONTINUUM THEORY**

- 3.1.1 Concept of Stress in Solids
- 3.1.2 Special Stress States and Stress Conditions
  - 3.1.2.1 Principal stresses
  - 3.1.2.2 St. Venant's principle
  - 3.1.2.3 Two dimensional stress states
- 3.1.3 Equation of Motion in Solids
- 3.1.4 Deformation and Strain
- 3.1.5 Constitutive Relations or Connecting the Stress to the Strain
  - 3.1.5.1 General behavior
  - 3.1.5.2 Homogeneous isotropic materials

### **3.2 EXAMPLES**

- 3.2.1 Simple Deformations

### 3.3 SOLVING THE FIELD EQUATIONS

- 3.3.1 Uniaxial Tension
- 3.3.2 Biaxial Tension
- 3.3.3 Triaxial Stress Case

### 3.4 APPLICATION TO SIMPLE BEAMS

### 3.5 GENERAL METHODS FOR SOLVING FIELD EQUATIONS OF ELASTICITY

- 3.5.1 Displacement Formulation
- 3.5.2 Stress Formulation
- 3.5.3 Mixed formulation
- 3.6 NUMERICAL METHODS
- 3.6.1 Introduction

### 3.7 DETAILED STRESS BEHAVIOR OF A FLEXIBLE COATING ON A RIGID DISK

### 3.8 STRAIN ENERGY PRINCIPLES

### 3.9 THE MARVELOUS MYSTERIOUS J INTEGRAL

## 4. ELEMENTARY FRACTURE MECHANICS OF SOLIDS - APPLICATION TO PROBLEMS OF ADHESION

### 4.1 INTRODUCTION

- 4.1.1 Introductory Concepts
  - 4.1.1.1 Strain energy approach
  - 4.1.1.2 Stress intensity factor approach

### 4.2 FRACTURE MECHANICS AS APPLIED TO PROBLEMS OF ADHESION

- 4.2.1 Elementary Computational Methods
  - 4.2.1.1 Basic model of thin coating on rigid disc
- 4.2.2 Decohesion Number Approach of Suo and Hutchinson
  - 4.2.2.1 The decohesion number
- 4.2.3 Back of the Envelope Calculations
  - 4.2.3.1 Polyimide on glass-ceramic
  - 4.2.3.2 Nickel on glass

### 4.3 SUMMARY

## 5 APPLIED ADHESION TESTING

### 5.1 THE PEEL TEST

- 5.1.1 Sample Preparation
- 5.1.2 Test Equipment
- 5.1.3 Peel Testing in Action
- 5.1.4 Advanced Peel Testing
  - 5.1.4.1 Thermodynamics of the peel test
  - 5.1.4.2 Deformation calorimetry

### 5.2 FULLY QUANTITATIVE PEEL TESTING

- 5.2.1 Earliest Work, Elastic Analysis
- 5.2.2 Elastic-Plastic Analysis
  - 5.2.2.1 Theory of elastic-plastic peeling for soft metals
- 5.2.3 Full Elastic-Plastic Analysis
  - 5.2.3.1 General equations for deformation of peel strip
  - 5.2.3.2 Basic goal
  - 5.2.3.3 Analysis strategy and assumptions

### 5.2.3.3 Equations of the elastica

### 5.2.2.2 Case 1, elastic peeling:

### 5.2.2.3 Case 2, elastic-plastic peeling/unloading

### 5.2.2.4 Case 3, elastic plastic loading and unloading

### 5.3 THE SCRATCH/CUT TEST

- 5.3.1 the Cut Test
- 5.3.2 Simplified Analytical Model for Cut Test

### 5.4 THE PULL TEST

### 5.5 SUMMARY

## 6 ADHESION ASPECTS OF COATING AND THIN FILM STRESSES

### 6.1 INTRODUCTION

### 6.2 GENERAL MEASUREMENT METHODS FOR THIN FILMS AND COATINGS

- 6.2.1 Cantilevered beam method
- 6.2.2 Variations on Bending Beam Approach
- 6.2.3 Optical measurement of deflection
  - 6.2.3.1 Microscopy
  - 6.2.3.2 Laser beam deflection
  - 6.2.3.3 Laser interferometry
  - 6.2.3.4 Capacitive measurement of deflection
  - 6.2.3.5 Stress Measurement by Vibrational Resonance
  - 6.2.3.6 Holography of suspended membrane
- 6.2.4 X-ray Measurements
- 6.2.5 Ultrasonics
  - 6.2.5.1 Through thickness stress measurement
  - 6.2.5.2 Surface stress measurement using skimming longitudinal waves
  - 6.2.5.3 Rayleigh wave method
  - 6.2.5.4 Surface skimming SH waves
- 6.2.6 Photoelasticity
- 6.2.7 Strain Relief Methods
- 6.2.8 Magnetics
  - 6.2.8.1 Barkhausen noise
  - 6.2.8.2 Magnetostriction approach
- 6.2.9 Raman spectroscopy
- 6.2.10 Miscellaneous Methods
  - 6.2.10.1 Stress Pattern Analysis by Thermal Emission (SPATE)
  - 6.2.10.2 Photoelastic coating technique
  - 6.2.10.3 Brittle lacquer method

## 7 CASE STUDIES FROM THE FIELD

### 7.1 A STUDY IN ADHESION SENSITIVITY TO CONTAMINATION

### 7.2 CASE OF THE IMPROPERLY CURED FILM

### 7.3 CASE OF THE STRESSED PIN

### 7.4 STABILITY MAPS

## APPENDIX A: VECTORS AND VECTOR CALCULUS

**APPENDIX B: NOTES ON ELEMENTARY STRENGTH OF MATERIALS (SOM) THEORY**

**APPENDIX C: MATERIAL PROPERTY DATA FOR SELECTED SUBSTANCES**

**APPENDIX D: DRIVING FORCE FORMULAE FOR A VARIETY OF LAMINATE STRUCTURES**

**APPENDIX E: SELECTED REFERENCES AND COMMENTARY ON ADHESION MEASUREMENT AND FILM STRESS LITERATURE**

**E1: GENERAL REFERENCES**

**E2: SELECTED REFERENCES ON ADHESION MEASUREMENT METHODS**

- E2.1 Blister test:
- E2.2 Scratch Test:
- E2.3 Indentation Debonding Test
- E2.4 Scotch Tape Test
- E2.5 Laser Spallation
- E2.6 Selected References on Mechanics of Peel Test
- E2.7 Non Destructive Methods

**E3: SELECTED REFERENCES ON STRESSES IN LAMINATE STRUCTURES AND COATINGS**

**E4: SELECTED REFERENCES ON FRACTURE MECHANICS AS RELATED TO PROBLEMS OF ADHESION OF FILMS AND COATINGS**

**E5: SELECTED REFERENCES ON STRESSES IN SOLIDS**

**APPENDIX F: GENERAL ADHESION MEASUREMENT REFERENCES**

REVIEW ARTICLES  
GENERAL ADHESION PAPERS  
ACOUSTIC EMISSION/ULTRASONIC METHODS  
BEND TEST  
BLISTER TEST  
DOUBLE CANTILEVERED BEAM TEST  
CENTRIFUGAL LOADING TEST  
ELECTROMAGNETIC TEST  
FRACTURE MECHANICS STUDIES  
INDENTATION TEST  
INTERNAL FRICTION  
IMPACT METHODS  
LAP SHEAR TEST  
LASER/ELECTRON SPALLATION  
MISCELLANEOUS METHODS  
PEEL TEST  
PULL TEST  
PULL OUT TEST  
PUSH OUT TEST  
RESIDUAL STRESS SELF LOADING TEST  
SCRATCH TEST  
TAPE TEST  
THEORETICAL STUDIES  
THERMAL METHODS  
TOPPLE BEAM METHOD  
WEDGE TEST